



Linear Systems replaces discontinued Siliconix PAD20

The PAD20 is a low leakage Pico-Amp Diode packaged in hermetic TO-72

The PAD20 extremely low-leakage diode provides a superior alternative to conventional diode technology when reverse current (leakage) must be minimized. The PAD20 features a leakage current of -20 pA and is well suited for use in applications such as input protection for operational amplifiers.

PAD20 Benefits:

- Negligible Circuit Leakage Contribution
- Circuit "Transparent" Except to Shunt High-Frequency Spikes
- Simplicity of Operation

PAD20 Applications:

- Op Amp Input Protection
- Multiplexer Overvoltage Protection

| FEATURES | | | | | | | |
|--|---------------------------|--|--|--|--|--|--|
| DIRECT REPLACEMENT FOR SILICONIX PAD20 | | | | | | | |
| REVERSE BREAKDOWN VOLTAGE | BV _R ≥ -45V | | | | | | |
| ULTRALOW LEAKAGE | ≤ 20 pA | | | | | | |
| REVERSE CAPACITANCE | $C_{rss} \le 2.0pF$ | | | | | | |
| ABSOLUTE MAXIMUM RATINGS | | | | | | | |
| @ 25°C (unless otherwise noted) | | | | | | | |
| | | | | | | | |
| Maximum Temperatures | | | | | | | |
| Storage Temperature | mperature -65°C to +150°C | | | | | | |
| Operating Junction Temperature | -55°C to +135°C | | | | | | |
| Maximum Power Dissipation | | | | | | | |
| Continuous Power Dissipation 300mW | | | | | | | |
| MAXIMUM CURRENT | | | | | | | |
| Forward Current (Note 1) | 50mA | | | | | | |

PAD20 ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted)

| SYMBOL | CHARACTERISTICS | MIN. | TYP. | MAX. | UNITS | CONDITIONS |
|----------------|---|------------------|------|------|-------|---------------------------|
| BV_R | Reverse <mark>Br</mark> eakdown Voltage | -4 5- | | | V | I _R =-1μΑ |
| V_{F} | Forward Voltage | | 0.8 | 1.5 | V | $I_F = 5mA$ |
| C_{rSS} | Total Reverse Capacitance | | 1.5 | 2 | pF | $V_R = -5V$, $f = 1$ MHz |
| I _R | Maximum Reverse Leakage Current | | | -20 | pA | V _R = - 20V |

Notes:

1. Absolute maximum ratings are limiting values above which PAD20 serviceability may be impaired.

Available Packages:

PAD20 in TO-72 PAD20 available as bare die

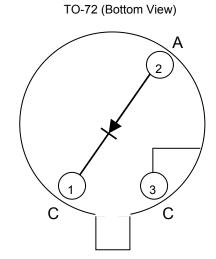
Please contact Micross for full package and die dimensions



Micross Components Europe

Tel: +44 1603 788967

Email: chipcomponents@micross.com
Web: http://www.micross.com/distribution.com



Information furnished by Linear Integrated Systems and Micross Components is believed to be accurate and reliable. However, no responsibility is assumed for its use; nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Linear Integrated Systems.